

RJE0605JPD

Silicon P Channel MOS FET Series Power Switching

REJ03G1803-0100
Rev.1.00
Apr 01, 2010

Description

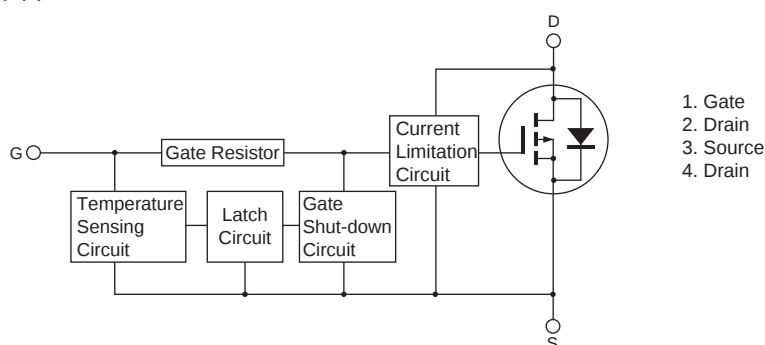
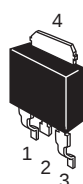
This FET has the over temperature shut-down capability sensing to the junction temperature. This FET has the built-in over temperature shut-down circuit in the gate area. And this circuit operation to shut-down the gate voltage in case of high junction temperature like applying over power consumption, over current etc..

Features

- Logic level operation (-6 V Gate drive).
- Built-in the over temperature shut-down circuit.
- High endurance capability against to the short circuit.
- Latch type shut down operation (need 0 voltage recovery).
- Built-in the current limitation circuit.
- Low on-resistance $R_{DS(on)}$: $58\text{ m}\Omega$ Typ, $75\text{ m}\Omega$ Max ($V_{GS} = -10\text{ V}$)

Outline

RENESAS Package code: PRSS0004ZD-C
(Package name: DPAK (S))



Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-60	V
Gate to source voltage	V_{GSS}	-16	V
Gate to source voltage	V_{GSS}	2.5	V
Drain current	I_D ^{Note 3}	-10	A
Body-drain diode reverse drain current	I_{DR}	-10	A
Avalanche current	I_{AP} ^{Note 2}	-7	A
Avalanche energy	E_{AR} ^{Note 2}	210	mJ
Channel dissipation	P_{ch} ^{Note 1}	30	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	$-55\text{ } +150$	$^\circ\text{C}$

Notes: 1. Value at $T_c = 25^\circ\text{C}$
2. $T_{ch} = 25^\circ\text{C}$, $R_g \geq 50\text{ }\Omega$
3. It provides by the current limitation lower bound value.

Typical Operation Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Input voltage	V _{IH}	-3.5	—	—	V	
	V _{IL}	—	—	-1.2	V	
Input current (Gate non shut down)	I _{IH1}	—	—	-100	μA	V _i = -8 V, V _{DS} = 0
	I _{IH2}	—	—	-50	μA	V _i = -3.5 V, V _{DS} = 0
	I _{IL}	—	—	-1	μA	V _i = -1.2 V, V _{DS} = 0
Input current (Gate shut down)	I _{IH(sD)1}	—	-0.8	—	mA	V _i = -8 V, V _{DS} = 0
	I _{IH(sD)2}	—	-0.35	—	mA	V _i = -3.5 V, V _{DS} = 0
Shut down temperature	T _{SD}	—	175	—	°C	Channel temperature (dv/dt V _{GS} ≥ 500 V/ms)
Gate operation voltage	V _{OP}	-3.5	—	-12	V	
Drain current (Current limitation value)	I _{D limit}	-10	—	—	A	V _{GS} = -12 V, V _{DS} = -10 V ^{Note 4}

Notes; 4. Pulse test

Electrical Characteristics

(Ta = 25°C)

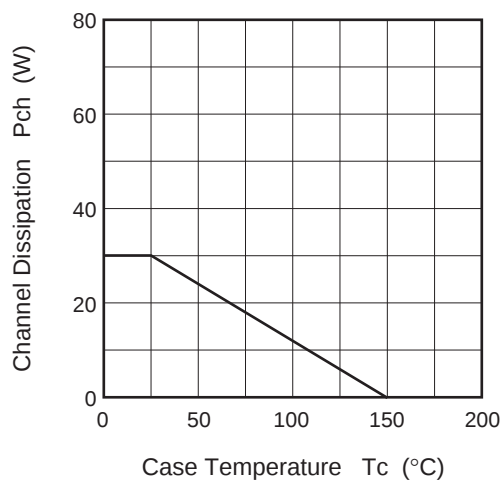
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain current	I _{D1}	—	—	-4	A	V _{GS} = -3.5 V, V _{DS} = -10 V
	I _{D2}	—	—	-10	mA	V _{GS} = -1.2 V, V _{DS} = -10 V
	I _{D3}	-10	—	—	A	V _{GS} = -12 V, V _{DS} = -10 V ^{Note 5}
Drain to source breakdown voltage	V _{(BR)DSS}	-60	—	—	V	I _D = -10 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	-16	—	—	V	I _G = -800 μA, V _{DS} = 0
	V _{(BR)GSS}	2.5	—	—	V	I _G = 100 μA, V _{DS} = 0
Gate to source leak current	I _{GSS1}	—	—	-100	μA	V _{GS} = -8 V, V _{DS} = 0
	I _{GSS2}	—	—	-50	μA	V _{GS} = -3.5 V, V _{DS} = 0
	I _{GSS3}	—	—	-1	μA	V _{GS} = -1.2 V, V _{DS} = 0
	I _{GSS4}	—	—	100	μA	V _{GS} = 2.4 V, V _{DS} = 0
Input current (shut down)	I _{GS(OP)1}	—	-0.8	—	mA	V _{GS} = -8 V, V _{DS} = 0
	I _{GS(OP)2}	—	-0.35	—	mA	V _{GS} = -3.5 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	-10	μA	V _{DS} = -60 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	-2.2	—	-3.4	V	V _{DS} = -10 V, I _D = -1 mA
Forward transfer admittance	y _{fs}	4	8	—	S	I _D = -5 A, V _{DS} = -10 V ^{Note 5}
Static drain to source on state resistance	R _{DS(on)}	—	75	110	mΩ	I _D = -5 A, V _{GS} = -6 V ^{Note 5}
	R _{DS(on)}	—	58	75	mΩ	I _D = -5 A, V _{GS} = -10 V ^{Note 5}
Output capacitance	C _{oss}	—	355	—	pF	V _{DS} = -10 V, V _{GS} = 0, f = 1MHz
Turn-on delay time	t _{d(on)}	—	4.5	—	μs	V _{GS} = -10 V, I _D = -5 A, R _L = 6 Ω
Rise time	t _r	—	4.0	—	μs	
Turn-off delay time	t _{d(off)}	—	1.8	—	μs	
Fall time	t _f	—	1.3	—	μs	
Body-drain diode forward voltage	V _{DF}	—	0.87	—	V	I _F = -10 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}	—	209	—	ns	I _F = -10 A, V _{GS} = 0 di/dt = 50 A/μs
Over load shut down operation time ^{Note 6}	t _{os1}	—	2.3	—	ms	V _{GS} = -6 V, V _{DD} = -16 V

Notes: 5. Pulse test

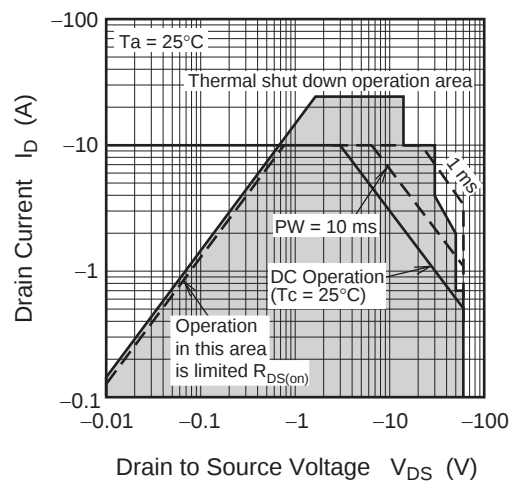
6. Including the junction temperature rise of the over loaded condition.

Main Characteristics

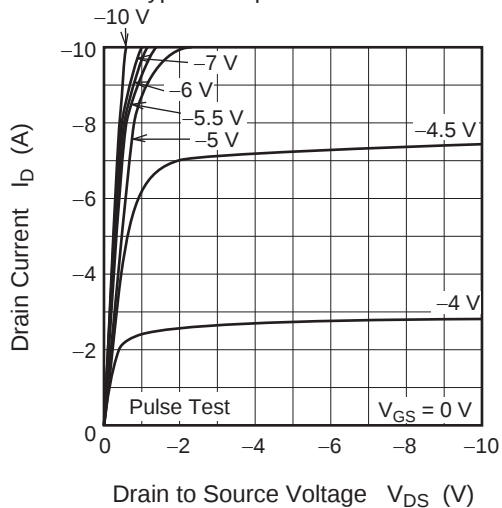
Power vs. Temperature Derating



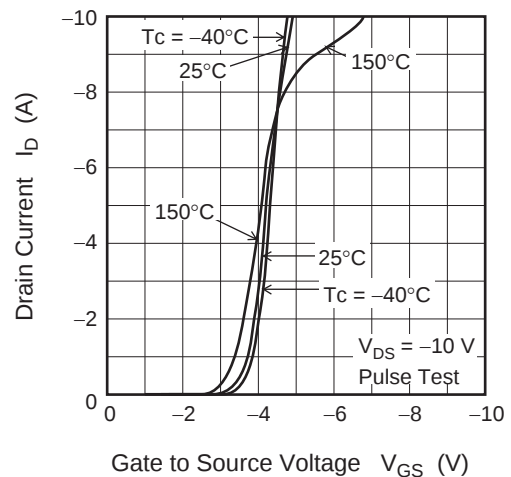
Maximum Safe Operation Area



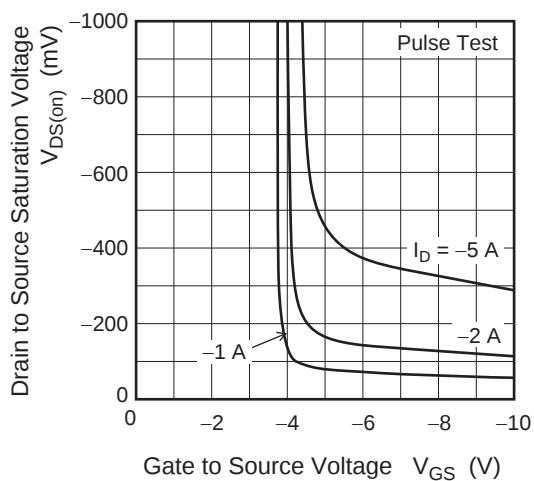
Typical Output Characteristics



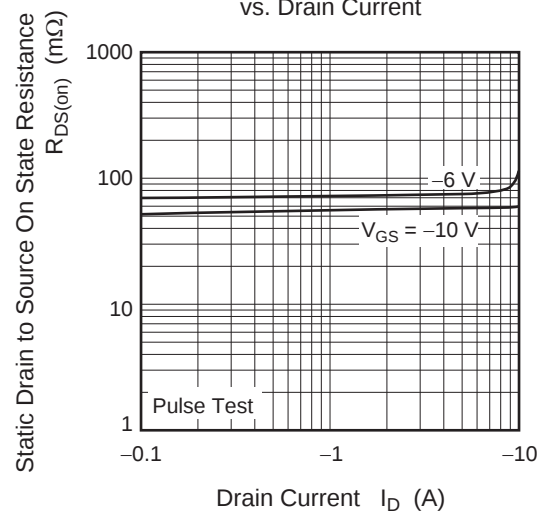
Typical Transfer Characteristics

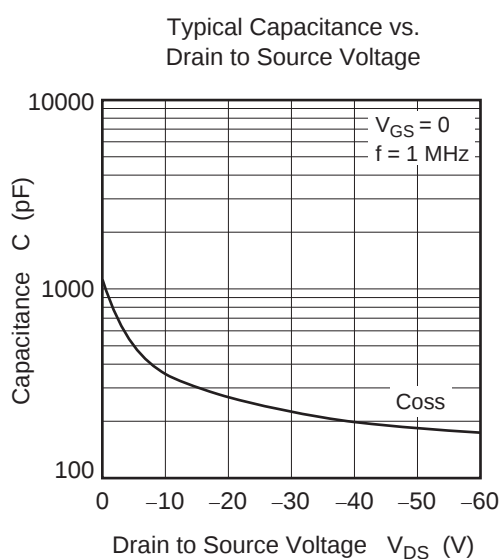
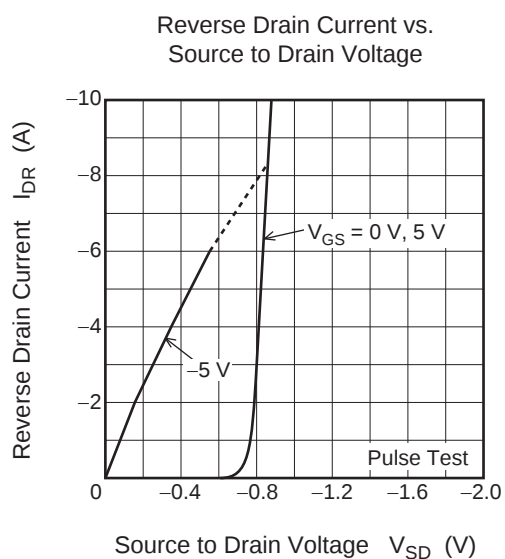
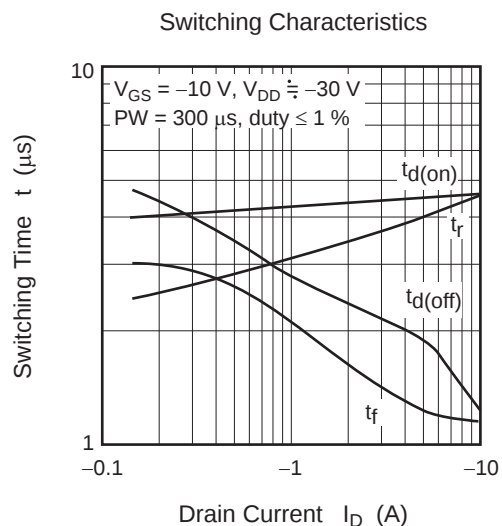
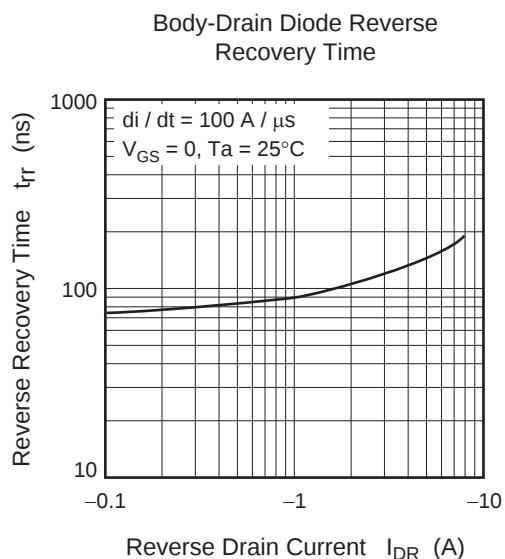
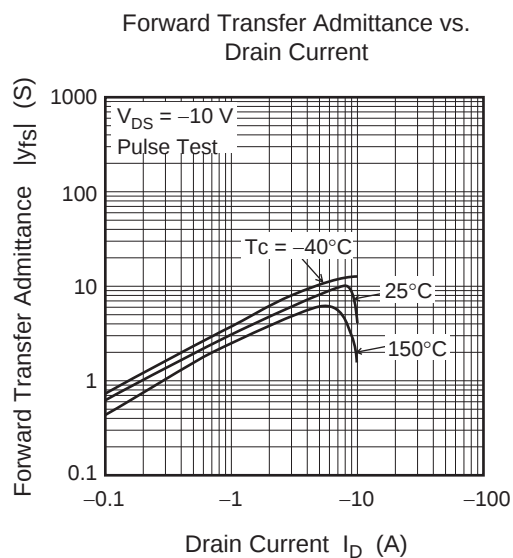
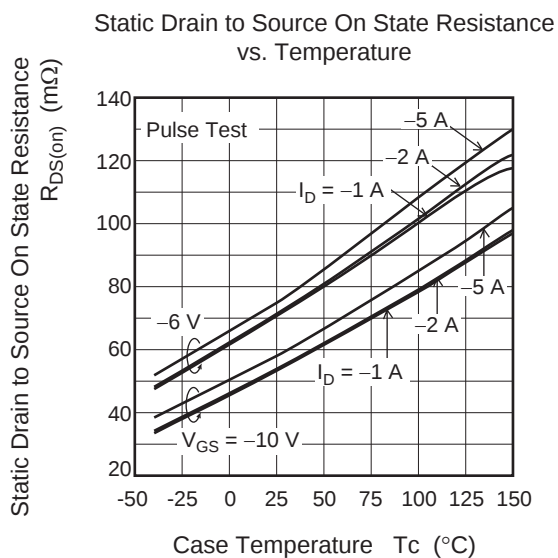


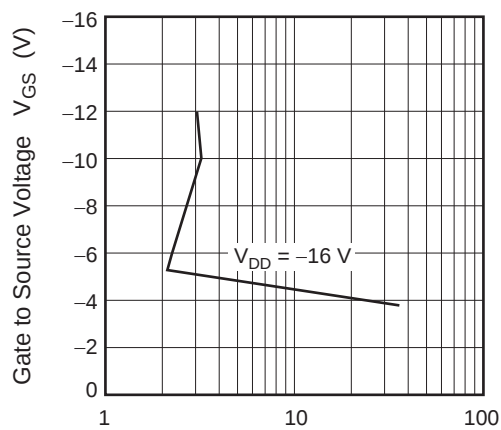
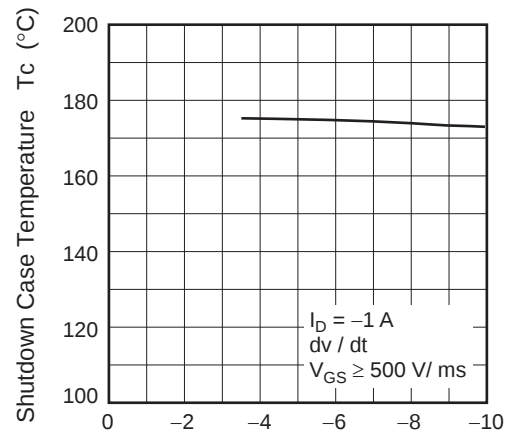
Drain Source Saturation Voltage vs. Gate to Source Voltage



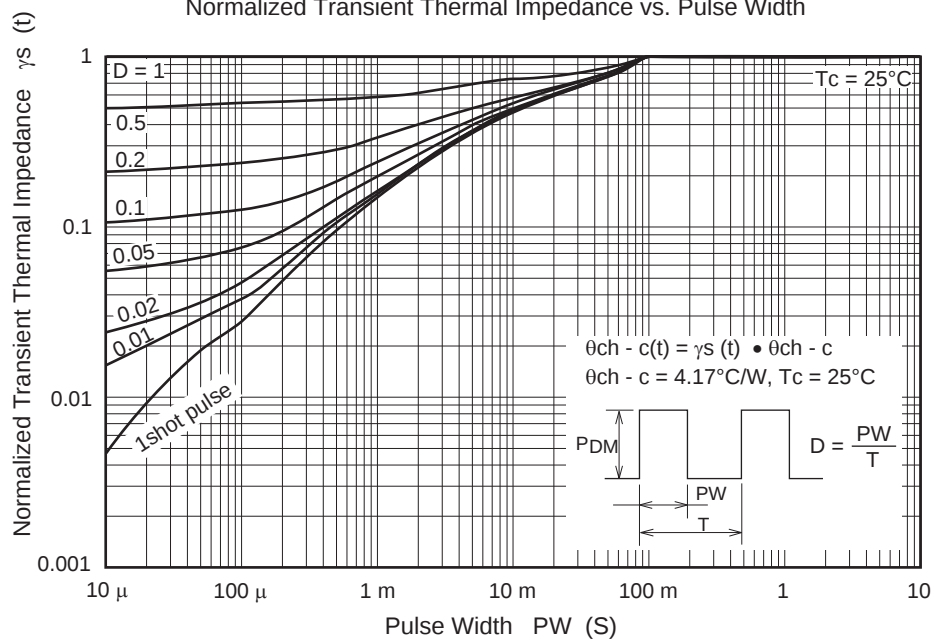
Static Drain to Source On State Resistance vs. Drain Current



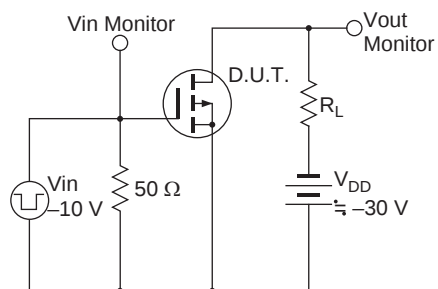


Gate to Source Voltage vs.
Shutdown Time of Load-Short TestShutdown Time of Load-Short Test P_w (ms)Shutdown Case Temperature vs.
Gate to Source VoltageGate to Source Voltage V_{GS} (V)

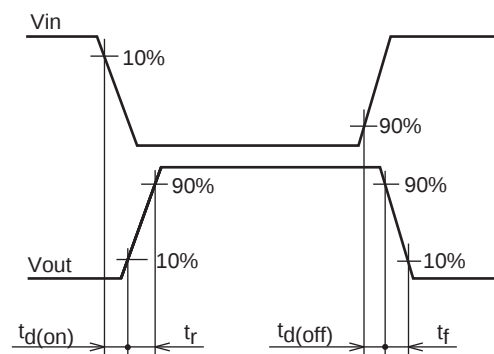
Normalized Transient Thermal Impedance vs. Pulse Width



Switching Time Test Circuit



Waveform



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